

International Scholarship Application

Excellence Scholarship - China, Taiwan, Hong Kong



Please complete this form by the scholarship application closing date for the semester your offer is for. Eligibility details and application closing dates can be found at bond.edu.au/scholarships/China.

Given Name

Family Name

Date of Birth (DD/MM/YY)

Country of Citizenship

Email Address

Bond University Student Number (found on your Letter of Offer)

Country of Residence

Program Applied for

Level of Study

Undergraduate

Postgraduate

Starting Semester

January

May

September

Supporting statement (up to 500 words) detailing why you believe you should be awarded with a Bond academic achievement scholarship:

All questions are mandatory and must be completed in full before submitting.

[Submit application](#)



bond.edu.au

CRICOS Provider Code 00017B

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